

Request For Quotation

Order the parts you need from our real-time inventory database. Simply complete a request for quotation form with your part information and a sales representative will respond to you with price and availability.

Request For Quotation

Your free datasheet starts on the next page.

More datasheets and data books are available from our homepage: http://www.datasheetarchive.com

FEATURES

■ Avalanche Rugged Technology

■ Rugged Gate Oxide Technology

■ Lower Input Capacitance

■ Improved Gate Charge

■ Extended Safe Operating Area

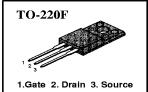
■ Lower Leakage Current : $25 \mu A (Max.)$ @ $V_{DS} = 600 V$

 \blacksquare Low $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$: 0.646 Ω (Typ.)

 $BV_{DSS} = 600 V$

 $R_{DS(on)} = 0.8 \Omega$

 $I_D = 5.1 A$



Absolute Maximum Ratings

Symbol	Characteristic	Value	Units		
V _{DSS}	Drain-to-Source Voltage		600	V	
1	Continuous Drain Current (T _C =25°C)		5.1	Α	
I _D	Continuous Drain Current (T _C =100°C)		3.2		
I _{DM}	Drain Current-Pulsed	0	36	Α	
V_{GS}	Gate-to-Source Voltage		<u>+</u> 30	٧	
E _{AS}	Single Pulsed Avalanche Energy	2	709	mJ	
l _{ar}	Avalanche Current	0	5.1	Α	
E _{AR}	Repetitive Avalanche Energy	0	5	mJ	
dv/dt	Peak Diode Recovery dv/dt	3	3.0	V/ns	
Б	Total Power Dissipation (T _C =25°C)		50	W	
P _D	Linear Derating Factor		0.4	W/°C	
T _J , T _{STG}	Operating Junction and		55 t150	T	
	Storage Temperature Range		- 55 to +150	°C	
TL	Maximum Lead Temp. for Soldering		200		
	Purposes, 1/8 "from case for 5-seco	nds	300		

Thermal Resistance

Symbol	Characteristic	Тур.	Max.	Units	
R _{eJC}	Junction-to-Case	-	2.5	°C/W	
R _{θJA}	Junction-to-Ambient		62.5	- C/ VV	



Rev. B

Electrical Characteristics (T_C =25°C unless otherwise specified)

Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition
BV _{DSS}	Drain-Source Breakdown Voltage	600	-	1	٧	$V_{GS} = 0V, I_D = 250 \mu A$
Δ BV/ Δ T $_{ m J}$	Breakdown Voltage Temp. Coeff.		0.66		V/°C	I _D =250μA See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	٧	$V_{DS} = 5V, I_{D} = 250 \mu A$
	Gate-Source Leakage, Forward			100	пA	V _{GS} =30V
I _{GSS}	Gate-Source Leakage, Reverse			-100	шА	V _{GS} =-30V
	Drain to Source Leakage Current		ł	25		V _{DS} =600V
I _{DSS}	Drain-to-Source Leakage Current			250	μΑ	V _{DS} =480V,T _C =125°C
В	Static Drain-Source					V 40VI 0.55A @
R _{DS(on)}	On-State Resistance			8.0	Ω	$V_{GS} = 10V, I_D = 2.55A$ 4
g _{fs}	Forward Transconductance		6.23		Ω	$V_{DS} = 50V, I_{D} = 2.55A$ 4
C _{iss}	Input Capacitance		1750	2270		\/ 0\/\/ 25\/f 1MU-
C _{oss}	Output Capacitance		190	220	рF	V _{GS} =0V,V _{DS} =25V,f =1MHz See Fig 5
C _{rss}	Reverse Transfer Capacitance		78	90		See Fig 5
t _{d(on)}	Turn-On Delay Time		20	50		\/ -200\/ -10A
t _r	Rise Time		23	55	ns	$V_{DD} = 300V, I_{D} = 10A,$
t _{d(off)}	Turn-Off Delay Time		85	180		$R_{\rm G}=6.2\Omega$
t _f	Fall Time		30	70		See Fig 13 ④⑤
Q_g	Total Gate Charge		74	95		$V_{DS} = 480V, V_{GS} = 10V,$
Q_gs	Gate-Source Charge		12		пC	I _D =10A
Q_{gd}	Gate-Drain("Miller ") Charge		35.4			See Fig 6 & Fig 12 ④⑤

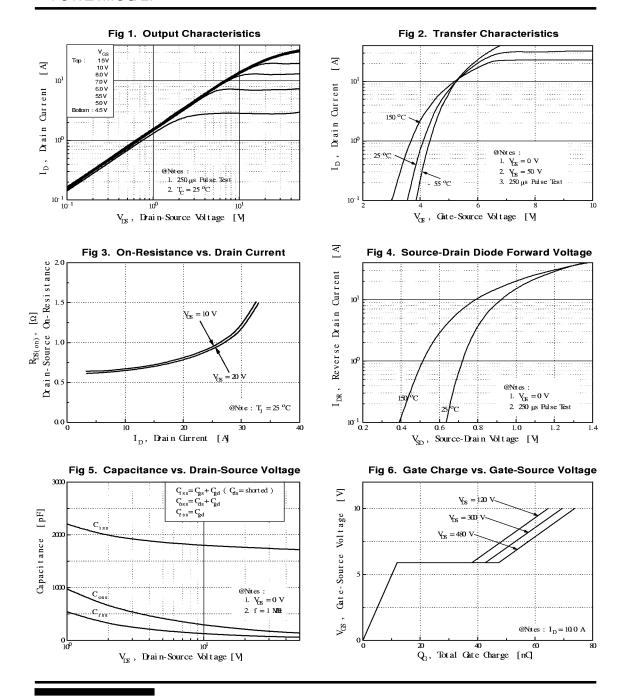
Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic		Min.	Тур.	Мах.	Units	Test Condition
Is	Continuous Source Current				5.1	Α	Integral reverse pn-diode
I _{SM}	Pulsed-Source Current	①	-		36	A	in the MOSFET
V _{SD}	Diode Forward Voltage	4			1.4	٧	T _J =25°C,I _S =5.1A,V _{GS} =0V
t _{rr}	Reverse Recovery Time			440		ns	T _J =25°C,I _F =10A
Q_{rr}	Reverse Recovery Charge			4.7		μС	$di_F/dt=100A/\mu s$

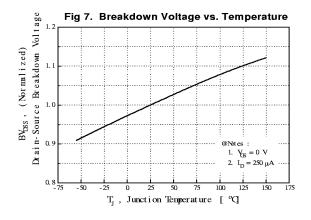
Notes;

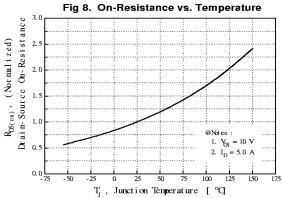
- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② L=50mH, $\rm I_{AS}$ =5.1A, $\rm V_{DD}$ =50V, $\rm R_{G}$ =27 Ω , Starting $\rm T_{J}$ =25 $^{\circ}\rm C$
- ③ I_{SD} ⊴ 0A, di/dt ⊴ 50A/ μs, V_{DD} ⊴BV_{DSS}, Starting T_J=25 °C ④ Pulse Test : Pulse Width = 250 μs, Duty Cycle ≤2%
- 5 Essentially Independent of Operating Temperature

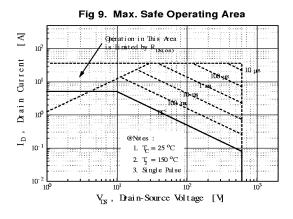


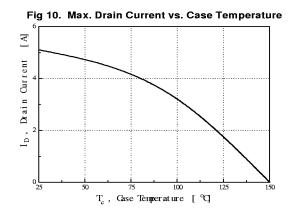


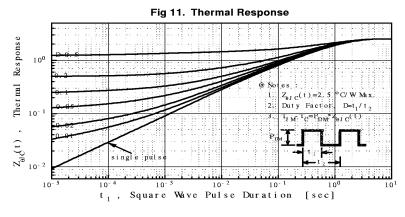
SSS10N60A











FAIRCHILD SEMICONDUCTOR™

Fig 12. Gate Charge Test Circuit & Waveform

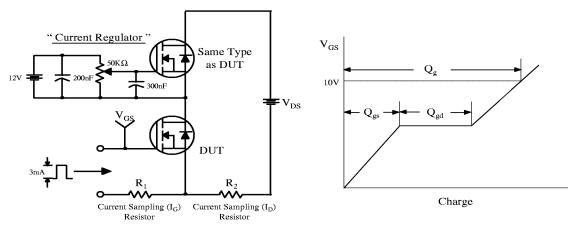


Fig 13. Resistive Switching Test Circuit & Waveforms

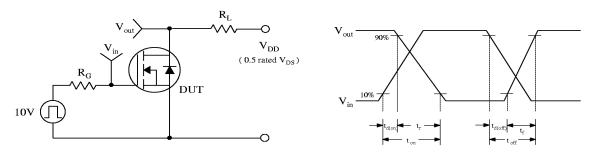
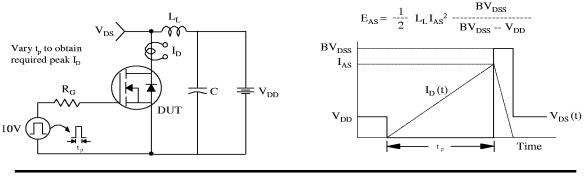


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



FAIRCHILD SEMICONDUCTOR™

Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

